

MM74HC86

Quad 2-Input Exclusive OR Gate

General Description

The MM74HC86 EXCLUSIVE OR gate utilizes advanced silicon-gate CMOS technology to achieve operating speeds similar to equivalent LS-TTL gates while maintaining the low power consumption and high noise immunity characteristic of standard CMOS integrated circuits. These gates are fully buffered and have a fanout of 10 LS-TTL loads. The 74HC logic family is functionally as well as pin out compatible with the standard 74LS logic family. All

inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

- Typical propagation delay: 9 ns
- Wide operating voltage range: 2–6V
- Low input current: 1 μ A maximum
- Low quiescent current: 20 μ A maximum (74 Series)
- Output drive capability: 10 LS-TTL loads

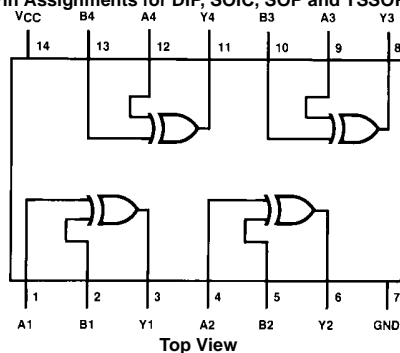
Ordering Code:

Order Number	Package Number	Package Description
MM74HC86M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
MM74HC86SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC86MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC86N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Pin Assignments for DIP, SOIC, SOP and TSSOP



Truth Table

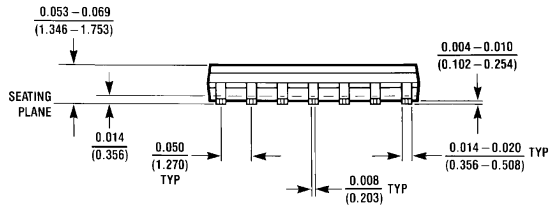
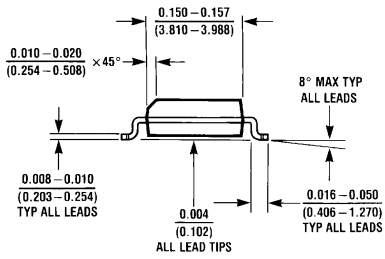
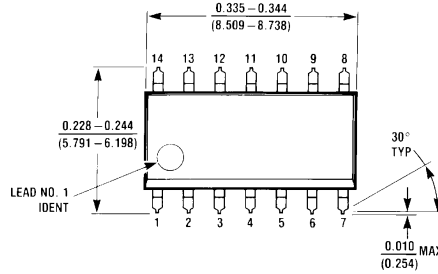
Inputs		Outputs
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	L

$$Y = A \oplus B = \bar{A}B + A\bar{B}$$

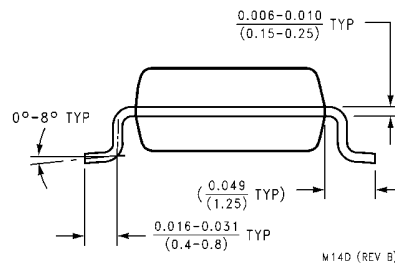
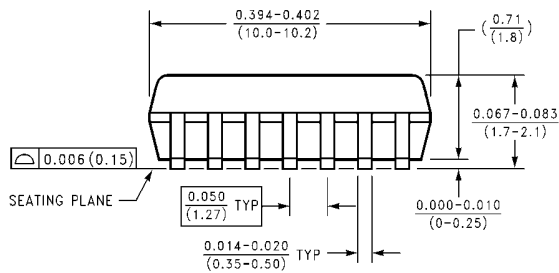
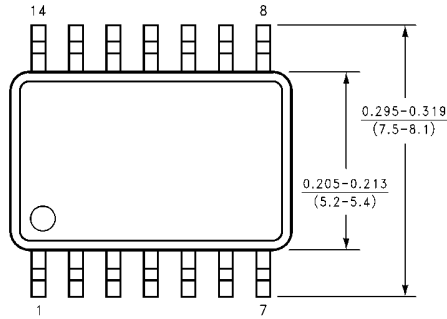
Absolute Maximum Ratings (Note 1)			Recommended Operating Conditions					
Supply Voltage (V_{CC})	-0.5 to +7.0V		Supply Voltage (V_{CC})	Min	Max	Units		
DC Input Voltage (V_{IN})	-1.5 to $V_{CC}+1.5V$		DC Input or Output Voltage	2	6	V		
DC Output Voltage (V_{OUT})	-0.5 to $V_{CC}+0.5V$		(V_{IN}, V_{OUT})	0	V_{CC}	V		
Clamp Diode Current (I_{IK}, I_{OK})	± 20 mA		Operating Temperature Range (T_A)	-40	+85	$^{\circ}C$		
DC Output Current, per pin (I_{OUT})	± 25 mA		Input Rise or Fall Times					
DC V_{CC} or GND Current, per pin (I_{CC})	± 50 mA		(t_r, t_f)	$V_{CC} = 2.0V$	1000	ns		
Storage Temperature Range (T_{STG})	-65 $^{\circ}C$ to +150 $^{\circ}C$			$V_{CC} = 4.5V$	500	ns		
Power Dissipation (P_D)				$V_{CC} = 6.0V$	400	ns		
(Note 3)	600 mW		Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.					
S.O. Package only	500 mW		Note 2: Unless otherwise specified all voltages are referenced to ground.					
Lead Temperature (T_L)			Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/ $^{\circ}C$ from 65 $^{\circ}C$ to 85 $^{\circ}C$.					
(Soldering 10 seconds)	260 $^{\circ}C$							
DC Electrical Characteristics (Note 4)								
Symbol	Parameter	Conditions	V_{CC}	$T_A = 25^{\circ}C$			Units	
				Typ	Guaranteed Limits			
V_{IH}	Minimum HIGH Level Input Voltage		2.0V		1.5	1.5	1.5	V
			4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V_{IL}	Maximum LOW Level Input Voltage		2.0V		0.5	0.5	0.5	V
			4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V_{OH}	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 20 \mu A$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		$V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 4.0$ mA $ I_{OUT} \leq 5.2$ mA	4.5V	4.2	3.98	3.84	3.7	V
			6.0V	5.7	5.48	5.34	5.2	V
V_{OL}	Maximum LOW Level Output Voltage	$V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 20 \mu A$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 4.0$ mA $ I_{OUT} \leq 5.2$ mA	4.5V	0.2	0.26	0.33	0.4	V
			6.0V	0.2	0.26	0.33	0.4	V
I_{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND	6.0V		± 0.1	± 1.0	± 1.0	μA
I_{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu A$	6.0V		2.0	20	40	μA
Note 4: For a power supply of 5V $\pm 10\%$ the worst case output voltages (V_{OH} and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.								

AC Electrical Characteristics									
$V_{CC} = 5V, T_A = 25^\circ C, C_L = 15 \text{ pF}, t_r = t_f = 6 \text{ ns}$									
Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units				
t_{PHL}, t_{PLH}	Maximum Propagation Delay		12	20	ns				
AC Electrical Characteristics									
$V_{CC} = 2.0V \text{ to } 6.0V, C_L = 50 \text{ pF}, t_r = t_f = 6 \text{ ns}$ (unless otherwise specified)									
Symbol	Parameter	Conditions	V_{CC}	$T_A = 25^\circ C$		$T_A = -40 \text{ to } 85^\circ C$		$T_A = -55 \text{ to } 125^\circ C$	
				Typ	Guaranteed Limits				
t_{PHL}, t_{PLH}	Maximum Propagation Delay		2.0V	60	120	151	179	ns	
			4.5V	12	24	30	36	ns	
			6.0V	10	20	26	30	ns	
t_{TLH}, t_{THL}	Maximum Output Rise and Fall Time		2.0V	30	75	95	110	ns	
			4.5V	8	15	19	22	ns	
			6.0V	7	13	16	19	ns	
C_{PD}	Power Dissipation Capacitance (Note 5)	(per gate)		25				pF	
C_{IN}	Maximum Input Capacitance			5	10	10	10	pF	
<p>Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.</p>									

Physical Dimensions inches (millimeters) unless otherwise noted



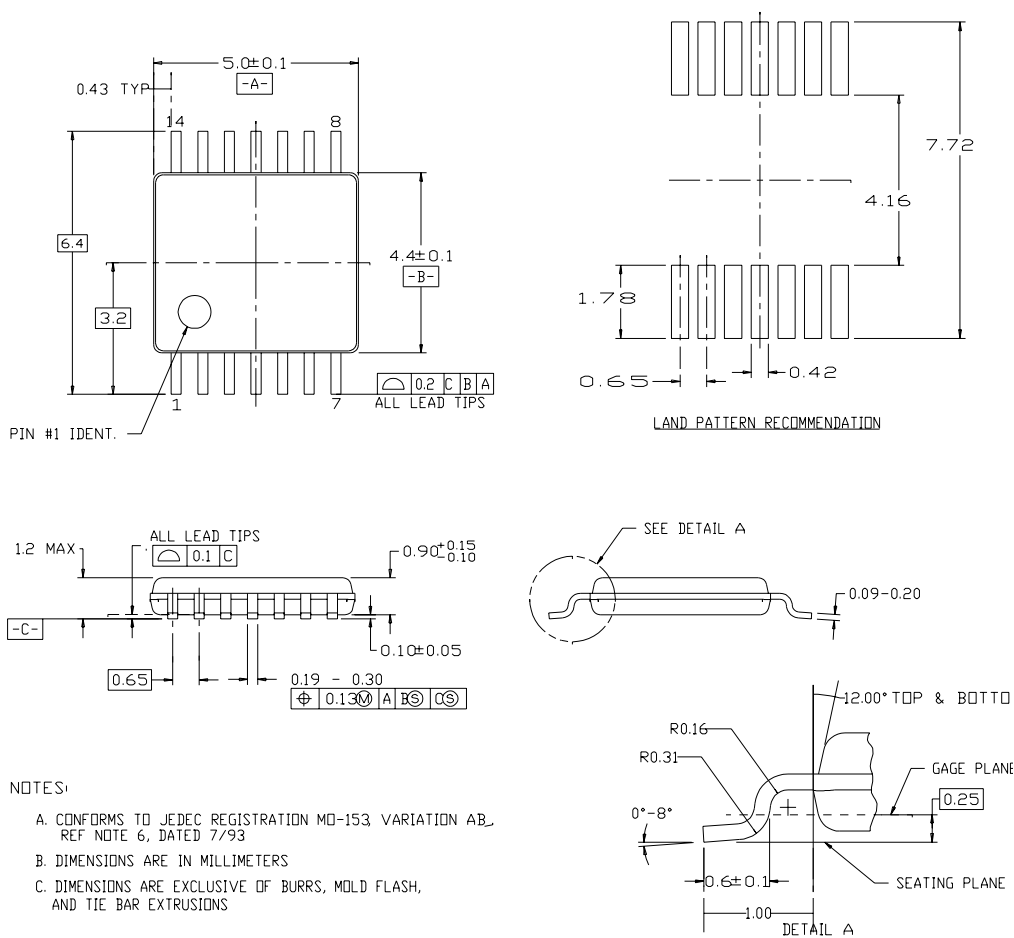
**14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
Package Number M14A**



**14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M14D**

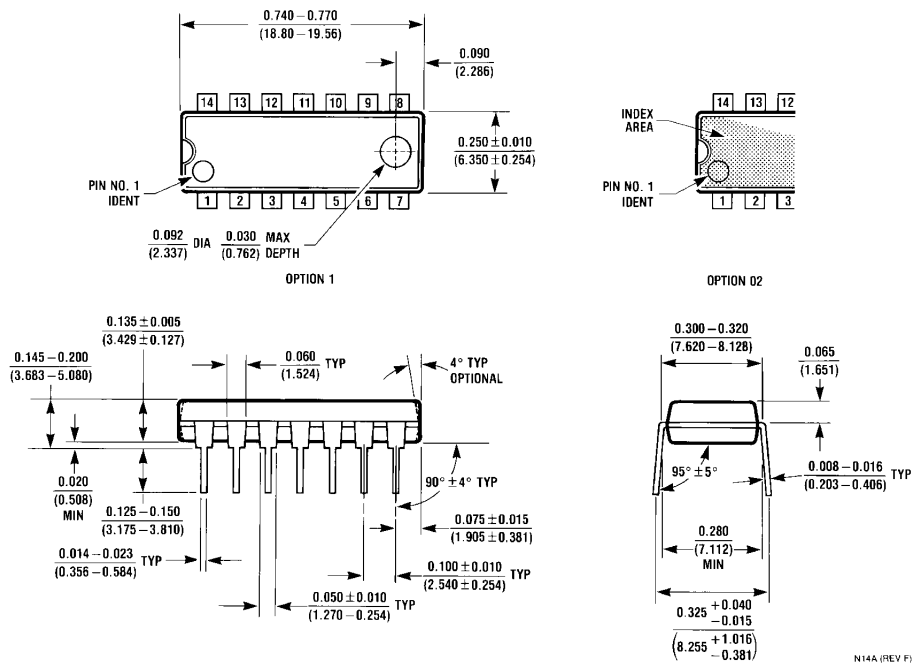
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

14LD, TSSOP, JEDEC MO-153, 4.4MM WIDE



**14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC14**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

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